

# STYCAST 2662 CAT 17

June 2019

**PRODUCT DESCRIPTION**

LOCTITE STYCAST 2662 CAT 17 provides the following product characteristics:

<b>Technology</b>	Epoxy
<b>Appearance (Resin)</b>	Black
<b>Product Benefits</b>	<ul style="list-style-type: none"><li>• High temperature resistance</li><li>• Excellent chemical resistance</li><li>• Good moisture resistance</li></ul>
<b>Cure</b>	Heat cure
<b>Application</b>	Encapsulation, Potting

LOCTITE STYCAST 2662 CAT 17 epoxy encapsulant is designed for potting electronic components exposed to harsh environments. This material is also ideal for large and complex castings that require high temperature chemical and moisture resistance.

LOCTITE STYCAST 2662 can be used with a variety of catalysts. For more information on mixed properties when used with other available catalysts, please contact your local technical service representative for assistance and recommendations.

**CATALYST DESCRIPTION**

LOCTITE CAT 17 provides the following product characteristics:

<b>Product Benefits</b>	<ul style="list-style-type: none"><li>• High temperature resistant</li><li>• Long work life</li><li>• High temperature performance</li><li>• Chemical resistant</li></ul>
<b>Cure</b>	Heat cure

**TYPICAL UNCURED PROPERTIES****LOCTITE STYCAST 2662**

Brookfield Viscosity, mPa·s (cP)	40,000
Density, g/cm <sup>3</sup>	1.44
Shelf Life @ 25°C, days	180
Flash Point - See SDS	

**TYPICAL UNCURED PROPERTIES AS MIXED****LOCTITE STYCAST 2662 with LOCTITE CAT 17**

Density, g/cm <sup>3</sup>	1.41
Mix Ratio, Material:Catalyst:	
By Weight	100 : 30
Work Life, 100 grams, @ 25 °C, hours	>24

**TYPICAL CURING PERFORMANCE****Cure Schedule****LOCTITE STYCAST 2662 with LOCTITE CAT 17**

Regular Castings	
3 hours @ 125°C plus 3 hours @ 175°C	

For larger or extremely critical castings

16 hours @ 65°C

plus 6 hours @ 125°C

plus 6 hours @ 150°C

Cure at any one of the recommended cure schedules.

For optimum performance, follow the initial cure with a post cure of 4 to 6 hours at the highest expected use temperature.

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

**TYPICAL PROPERTIES OF CURED MATERIAL****LOCTITE STYCAST 2662 with LOCTITE CAT 17****Physical Properties**

Hardness, Shore D	88
Coefficient of Thermal Expansion 10 <sup>-6</sup> /°C,	47
Thermal Conductivity, W/(m-K)	0.53
Water Absorption (24 hours), %	0.01
Operating temperature, °C	-20 to +230

**Electrical Properties**

Dielectric Strength, kV/mm	16.5
Volume Resistivity, ohm-cm:	
@ 25 °C	>10 <sup>16</sup>

**TYPICAL PERFORMANCE OF CURED MATERIAL****LOCTITE STYCAST 2662 with LOCTITE CAT 17****Miscellaneous**

Flexural Strength	N/mm <sup>2</sup>	100
	(psi)	(14,500)

**GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

**DIRECTIONS FOR USE**

1. To ensure the long term performance of the potted or encapsulated electrical/electronic assembly, complete cleaning of the substrates should be performed to remove contamination such as dust, moisture, salt, and oils which can cause electrical failure, poor adhesion or corrosion in an embedded part.

2. Some filler settling is common during shipping and storage. For this reason, it is recommended that the contents of the shipping container be thoroughly mixed prior to use. Power mixing is preferred to ensure homogeneous product.
3. Accurately weigh resin and hardener into a clean container in the recommended ratio. Weighing apparatus having an accuracy in proportion to the amounts being weighed should be used.
4. Blend components by hand, using a kneading motion, for 2 to 3 minutes. Scrape the bottom and sides of the mixing container frequently to produce a uniform mixture. If possible, power mix to an additional 2 to 3 minutes. Avoid high mixing speeds which could entrap excessive amounts of air or cause overheating of the mixture resulting in reduced working life.
5. To ensure a void-free embedment, vacuum de-airing should be used to remove any entrapped air introduced during the mixing operation. Vacuum de-air mixture at 1 to 5 mm mercury. The foam will rise several times the liquid height and then subside. Continue to vacuum de-airing until most of the bubbling has ceased. This usually requires 3 to 10 minutes.
6. To facilitate deairing in difficult to deair materials, add 1 to 3 drops of an air release agent, such as ANTIFOAM 88 into 100 grams of mixture.
7. Gentle warming will also help, but pot life will be shortened.
8. Pour mixture into cavity or mold. Gentle warming of the mold or assembly reduces the viscosity. This improves the flow of the material into the unit having intricate shapes or tightly packed coils or components. Further vacuum deairing in the mold may be required for critical applications.

**STORAGE:**

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

**Optimal Storage : 25 °C**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

**Disclaimer****Note:**

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

Any liability in respect of the information in the Technical Data Sheet or any other written or oral recommendation(s) regarding the concerned product is excluded, except if otherwise explicitly agreed and except in relation to death or personal injury caused by our negligence and any liability under any applicable mandatory product liability law.

**In case products are delivered by Henkel Belgium NV, Henkel Electronic Materials NV, Henkel Nederland BV, Henkel Technologies France SAS and Henkel France SA please additionally note the following:**

In case Henkel would be nevertheless held liable, on whatever legal ground, Henkel's liability will in no event exceed the amount of the concerned delivery.

**In case products are delivered by Henkel Corporation, Resin Technology Group, Inc., or Henkel Canada Corporation, the following disclaimer is applicable:**

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, **Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits.** The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

**Trademark usage:** [Except as otherwise noted] All trademarks in this document are trademarks and/or registered trademarks of Henkel and its affiliates in the U.S. and elsewhere.

## Reference 1

<p>Supplied by:</p> <p><a href="http://www.hitek-ltd.co.uk">www.hitek-ltd.co.uk</a></p> <p>+44 (0)1724 851678</p>	 <p><b>HITEK</b></p> <p>ELECTRONIC MATERIALS LTD</p>
---	---